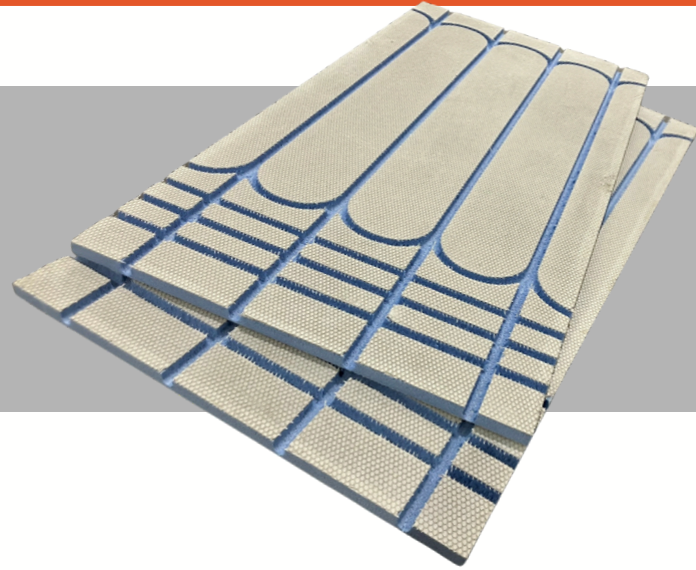




TEKGROUP



LITE LP - 16mm UFH BOARD

**A low-profile insulated
under floor heating board.**

**A high compressive strength 300 kPa XPS
underfloor heating insulation board for low
profile systems.**

**It has durable cement coatings on either face
that are suitable for the direct application of
tiles or wood flooring (on underlay).**

**The board size is 1200mm x 600mm x 16mm,
being grooved on one face as required to suit
12mm diameter underfloor heating pipes, with
radius returns as standard.**

**Other routed pipe layouts and patterns are
available, further details upon request from
the Sales Office.**

 **TEKWARM**

INSTALLATION

Tekwarm Lite LP UFH Boards make for a speedy installation over a flat level sub floor.

TIMBER BASE

For applications onto timber the panels should always be fixed with Tekwarm mechanical fixings and washers. Fixings should be of a suitable length for application.

CONCRETE BASE

Tekwarm boards laid directly onto concrete should be adhered with a bed of combed tile adhesive (S1 or equivalent). On occasions mechanical fixings will also be required dependant on substrate.

FINISHING

For most applications an additional board is not required and flooring can be laid directly to the upper surface.

- Wood flooring products should be applied using a suitable underlay as per manufacturer's instructions.
- Flooring grade tiles can be laid on a suitable combed tile adhesive layer.
- Other finishes will require a separating layer of Tekwarm Construction Board prior to their installation.

SUITABLE FOR

Tekwarm Lite LP UFH Board is suitable for new build or retro fit installations, and the standard pattern board is normally available from stock.

TEKGROUP

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